

RELIABILITY REPORT FOR

DS9092GT

Dallas Semiconductor

4401 South Beltwood Parkway Dallas, TX 75244-3292

Prepared by:

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

DS9092GT

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport/dsreliability.html.

Device Description:

A description of this assembly can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Note: Due to the nature of the construction on this assembly, there is no operating life data collected.

The reliability data follows. Some of the data in this report may be generic. A the start of this data is a description of the assembly vehicle used to generate this reliability data. The next section is the detailed reliability data for each stress. If there are additional assemblies used as part of this report, a description of each will follow which includes the respective reliability data for that assembly. The reliability data section includes the latest data available.

Assembly Information:

Assembly Site: BTW China

Pin Count: 2

Package Type: Dongle/Fob

Body Size: 0
Mold Compound: ?
Lead Frame: ?
Lead Finsh:

Die Attach: ?
Bond Wire / Size: /

Flammability: UL 94-V0

Moisture Sensitivity (JEDEC J-STD20A)

Date Code Range: 9849 to 9849

TEMPERATURE HUMIDITY BIAS

DESCRIPTION	DATE CODE CONDITION		REA	DPOINT	QUANTITY	FAILS
BIASED MOISTURE	9849	85/85, 5.5 VOLTS	274	HRS	50	0
				Tota	al:	0

Assembly Information:

Assembly Site: Dallas Pin Count: 2

Package Type: Dongle/Fob

Body Size: 0
Mold Compound: ?
Lead Frame: ?
Lead Finsh:

Die Attach: ?
Bond Wire / Size: /

Flammability: UL 94-V0

Moisture Sensitivity (JEDEC J-STD20A)

Date Code Range: 0328 to 0328

MECHANICAL LIFE

DESCRIPTION DATE CODE CONDITION READPOINT QUANTITY FAILS MECHANICAL SHOCK 0328 200G, 1/2 SINE, 6 MS 30 CYS 50 0 VIBRATION, VARIABLE F 0328 10g or 0.06", 5Hz-2KHz, X Y Z axis 9 HRS 50 0

Total: 0

STORAGE LIFE

DESCRIPTION DATE CODE CONDITION READPOINT QUANTITY FAILS

STORAGE LIFE 0328 85 C 1000 HRS 50 0

Total: 0

TEMPERATURE CYCLE

DESCRIPTION DATE CODE CONDITION READPOINT QUANTITY FAILS

TEMP CYCLE 0328 -40 TO 85C 1000 CYS 50 0

Total: 0

UNBIASED MOISTURE RESISTANCE

DESCRIPTION DATE CODE CONDITION READPOINT QUANTITY FAILS

MOISTURE SOAK 0328 60C/90% R.H. 1000 HRS 50 0

Total: 0